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(54) **DISPLAY SUBSTRATE AND
MANUFACTURING METHOD THEREOF,
AND DISPLAY DEVICE**

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ABSTRACT

A display substrate, a manufacturing method thereof and a display device are provided. The display substrate includes: a base substrate; a first conductive element located on the base substrate; a first planarization layer located on the first conductive element; a second conductive element located on the first planarization layer and connected to the first conductive element through a first via hole penetrating through the first planarization layer; a second planarization layer located on the second conductive element; and a conductive line located on the second planarization layer; the second conductive element is recessed at the first via hole, the second planarization layer has a light-shielding portion, and an orthographic projection of the first via hole on the base substrate falls within an orthographic projection of the light-shielding portion on the base substrate.

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